

# **BHDS1100**

# **SCHOTTKY** SURFACE BRIDGE RECTIFIER

REVERSE VOLTAGE **FORWARD CURRENT**  - 100 Volts

- 1.0 Amperes

## **FEATURES**

- Rating to 100V PRV
- · Ideal for printed circuit board
- · Reliable low cost construction utilizing molded plastic technique
- Qualified according to AEC-Q101 Rev\_C

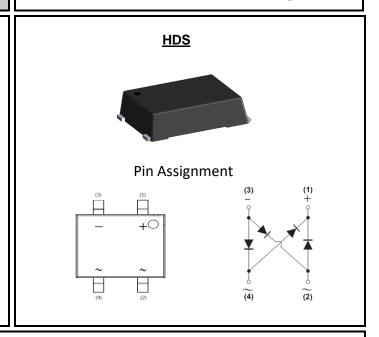
#### **APPLICATION**

- Energy saving Lamps
- Mobile Battery charger

## **MECHANICAL DATA**

- Case Material: "Green" molding compound, UL flammability classification 94V-0, "Halogen-free".
- Moisture Sensitivity: Level 1 per J-STD-020
- · Lead free finish, RoHS compliant
- Weight: 92.3 mg (Approximate)

Marking code: B1100



## MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.

#### **ABSOLUTE RATINGS**

PARAMETER		SYMBOL	VALUE	UNIT
Maximum repetitive peak reverse voltage		V <sub>RRM</sub>	100	V
Maximum DC blocking voltage		V <sub>DC</sub>	100	V
Maximum Average rectified output current	@T <sub>C</sub> =140°C	I <sub>(AV)</sub>	1.0	A
Peak forward surge current 8.3ms single half sin Superimposed on rated load.	e-wave	I <sub>FSM</sub>	30	А
I <sup>2</sup> t Rating for fusing (1ms <t<8.3ms)< td=""><td>l<sup>2</sup>t</td><td>3.7</td><td>A<sup>2</sup>S</td></t<8.3ms)<>		l <sup>2</sup> t	3.7	A <sup>2</sup> S
Operating junction and Storage Temperature rai	nge	T <sub>J.</sub> T <sub>STG</sub>	-55 ~ +150	°C

# STATIC ELECTRICAL CHARACTERISTICS

PARAMETER	TEST CONDITIONS		SYMBOL	TYP	MAX	UNIT		
Forward voltage (Note1)	I <sub>F</sub> =1.0A	T <sub>J</sub> =25°C	V-		0.85	V		
Forward voltage (Note I)	IF=1.UA	T <sub>J</sub> =125°C	V <sub>F</sub>		0.60	v		
Lookaga aurrant	V <sub>R</sub> =100V	T <sub>J</sub> =25°C			50	uA		
Leakage current	V R= 100 V	T <sub>J</sub> =100°C	IR		5	mA		
Typical junction capacitance (Note 2)			Сл	55	5	pF		

#### THERMAL CHARACTERISTICS

PARAMETER	SYMBOL	TYP		UNIT
Typical thermal resistance (Note 3)	$RthJ_A$	10		°C/W
Typical thermal resistance (Note 3)	RthJ <sub>C</sub>	6		C/VV
Note:			REV2, Dec-2020, K	BHB02

300us pulse width, 2% duty cycle.

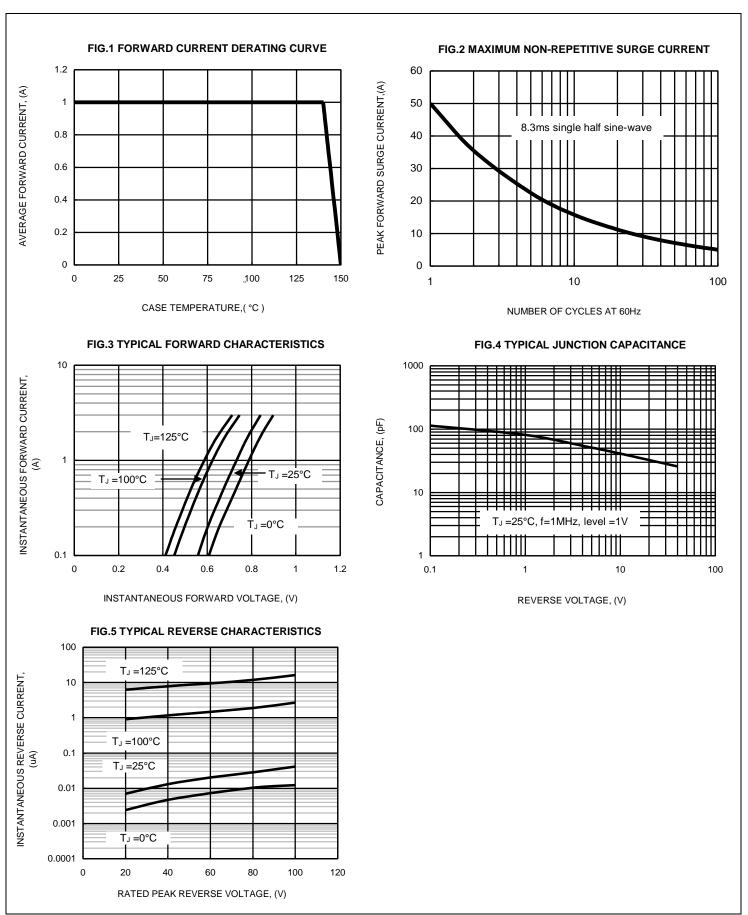
Measured at 1.0MHz and applied voltage of 4.0VDC.

Thermal resistance test performed in accordance with JESD-51.

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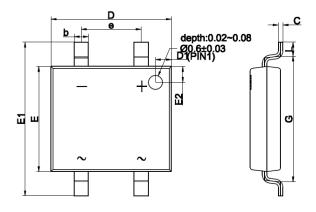
# RATING AND CHARACTERISTIC CURVES BHDS1100

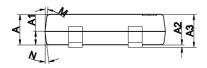






# **Package Dimension:**

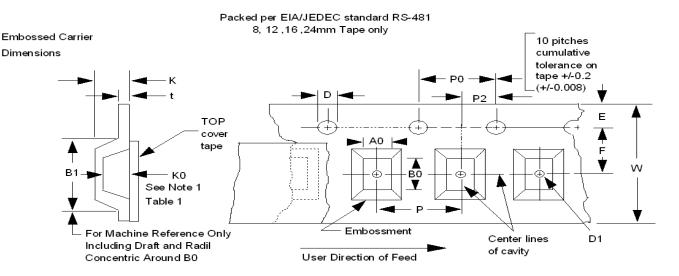




HDS							
DIM	MIN	MAX					
Α	1.20	1.30					
A1	0.43	0.63					
A2	0.00	0.15					
A3	1.20	1.40					
b	0.45	0.75					
С	0.10	0.30					
D	4.85	5.25					
D1	0.45	0.85					
е	2.54 TYP.						
E	4.25	4.65					
E1	6.40	6.80					
E2	0.45	0.85					
G	5.20	5.60					
L	0.40	0.80					
М	7° TYP.						
N	7° TYP.						
All dim	ension in mil	llimeter					



## **Embossed Carrier Dimensions**



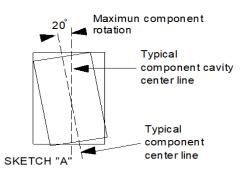
#### **EMBOSSED TYPE**

# **ALL DIMENSION IN MILLIMETERS AND (INCHES)**

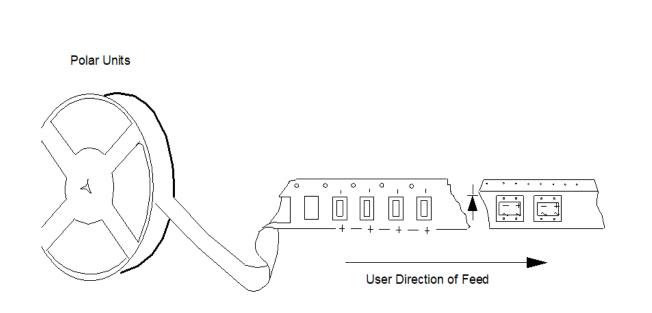
TAPE SIZE	D	E	РО	t (MAX)	A0B0K0	
12mm	1.55+0.10/-0.0 (0.059 +0.004 -0.00)	1.75+/-0.10 (0.069+/-0.004)	4.0+/-0.10 (0.157+/-0.004)	0.6 (0.024)	SEE NOTE 1	CONSTANT DIMENSION

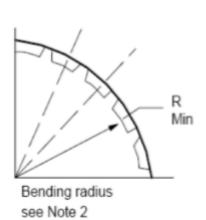
TAPE SIZE	B1 MAX	D1 MIN	F	K MAX	P2	R	W	Р	VARIABLE
12mm	8.2 (0.323)	1.5 (0.59)	5.5+/-0.05 (2.17+/-0.0 02)	4.5 (0.117)	2.0+/-0.05 (0.079+/-0.002)	30 (1.181)	12.0+/-0.30 (0.472+/-0.0 12)	8.0+/10 (0.315+/-0.0 04)	DIMENSIONS

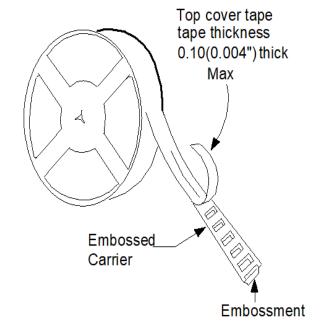
- Note 1: A0B0K0 are determined by component size. The clearance between the component and the cavity must bewithin 0.05 min. to 0.50 max. for 8 mm tape. 0.05 min. to 0.65 max. for 12mm tape. 0.15 min. to 0.90 max. for 16mm tape and 0.05 min. to 1.00 max. for 24 mm tape and larger .the component cannot rotate more than 20 within the determined cavity . see sketch "A" below.
  - 2: Tape and component shall pass around radius "R" without damage



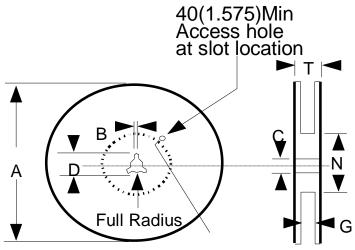










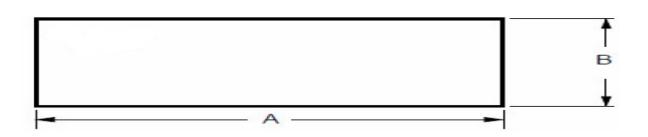


Tape slot in core for tape start 2.5(0.098)Min. width. 10(0.394)Min.depth.

## **REEL DIMENSIONS**

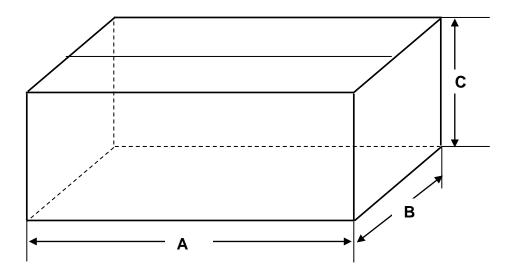
TAPE SIZE	A MAX	B MAX	С	D MIN	N MIN	G	T MAX
12mm	330	1.5	13.0+/-0.5	20.2	7.5	12.4+2.0/-0.0	18.4
	(13.0)	(0.06)	(0.512+/-0.020)	(0.80)	(2.952)	(0.488+0.078/-0.0)	(0.724)

# 1. SMA/B 襯板





# 2. CARTON



## **UNIT:mm**

DEVICE	Q'TY/REEL	REEL DIA	襯板 SIZE	CARTON SIZE (mm)	Q'TY/CARTON
TYPE	(PCS)	(mm)	(mm)		(PCS)
HDS	3000	330	1300x200	355x245x350	36K



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